

DG1S4

Schottky Barrier Diodes 40V, 1A

Feature

- Ultra-small SMD
- Ultra thin PKG
- · Low V_F
- · Based on AEC-Q101
- Pb free terminal
- RoHS:Yes

OUTLINE

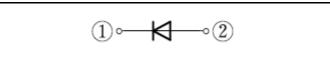
Package (House Name): G1F

Package (JEDEC Code): DO-219AB similar

Package (JEITA Code): SC-109



Equivalent circuit



Absolute Maximum Ratings (unless otherwise specified : TI=25°C)

| Item | Symbol | Conditions | Ratings | Unit |
|---------------------------------|---------------------|---|------------|------|
| Storage temperrature | Tstg | | -55 to 150 | °C |
| Junction temperature | Tj | | -55 to 150 | °C |
| Repetitive peak reverse voltage | V_{RRM} | | 40 | V |
| Average forward current | I _F (AV) | 50Hz sine wave, Resistance load, Ta=36°C * | 1 | Α |
| Average forward current | I _F (AV) | 50Hz sine wave, Resistance load, Ta=27°C * | 0.7 | Α |
| Surge forward current | I _{FSM} | 50Hz sine wave, Non-repetitive, 1cycle, Peak value, Tj=25°C | | А |

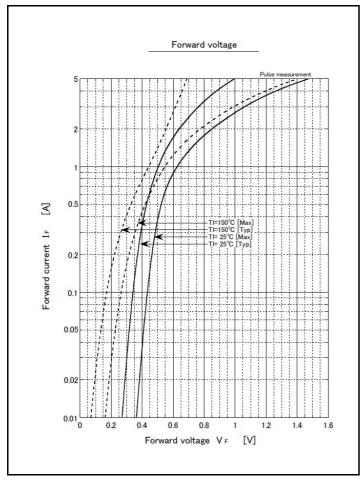
^{* :}See the original Specifications

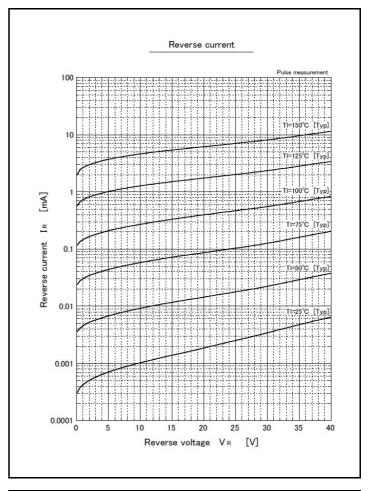
Electrical Characteristics (unless otherwise specified : TI=25°C)

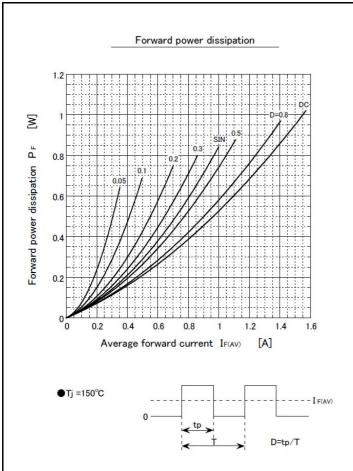
| Item | Symbol | Conditions | Ratings | | | Unit |
|--------------------|----------------|--|---------|-----|------|---------|
| | | | MIN | TYP | MAX | O.I.I.C |
| Forward voltage | V _F | IF=0.7A, Pulse measurement | | | 0.55 | V |
| Reverse current | I _R | VR=40V, Pulse measurement | | | 0.8 | mA |
| Total capacitance | Ct | f=1MHz, VR=10V | | 37 | | pF |
| Thermal resistance | Rth(j-l) | Junction to lead, On alumina substrate * | | | 20 | °C/W |
| Thermal resistance | Rth(j-a) | Junction to ambient, On alumina substrate * | | | 70 | °C/W |
| Thermal resistance | Rth(j-a) | Junction to ambient, On paper phenol substrate * | | | 120 | °C/W |
| Thermal resistance | Rth(j-a) | Junction to ambient, On paper phenol substrate * | | | 210 | °C/W |

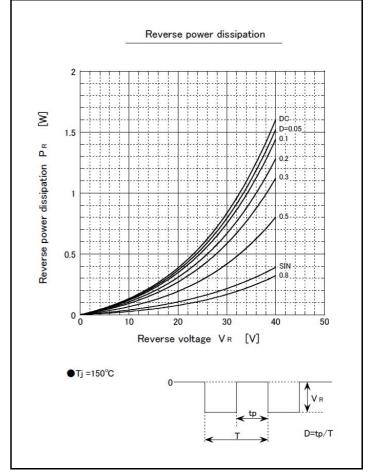
^{*} :See the original Specifications

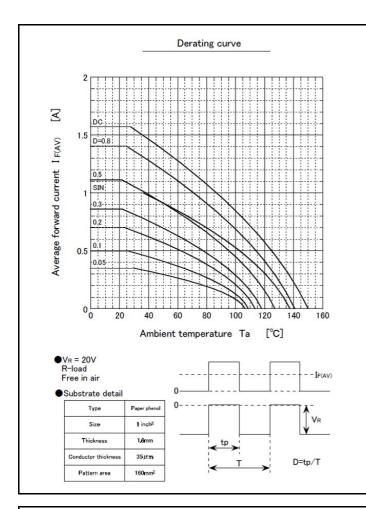
CHARACTERISTIC DIAGRAMS

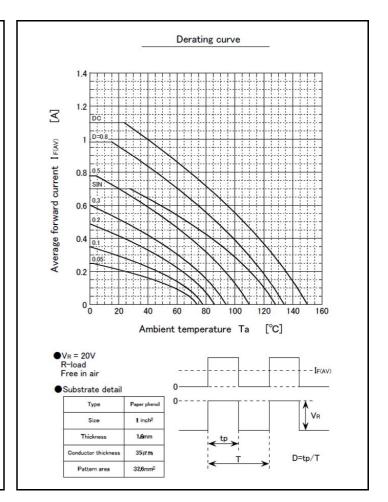


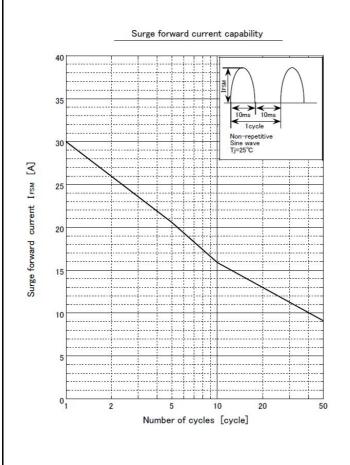


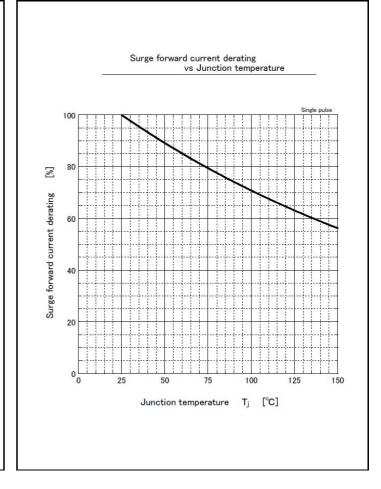


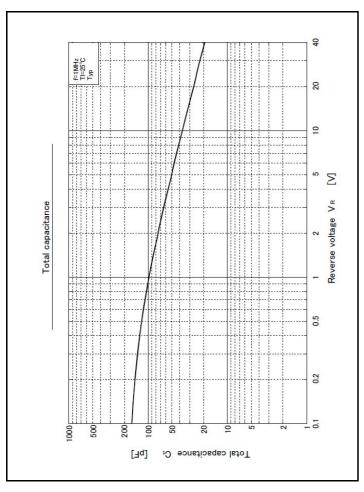


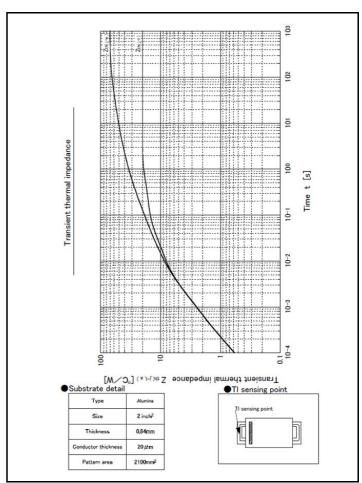


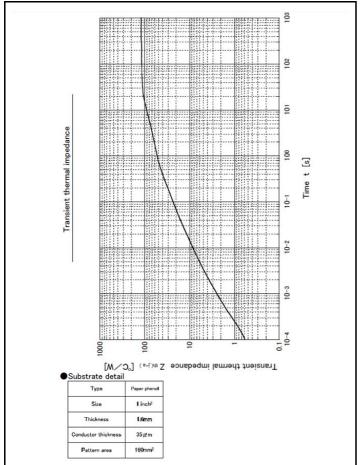


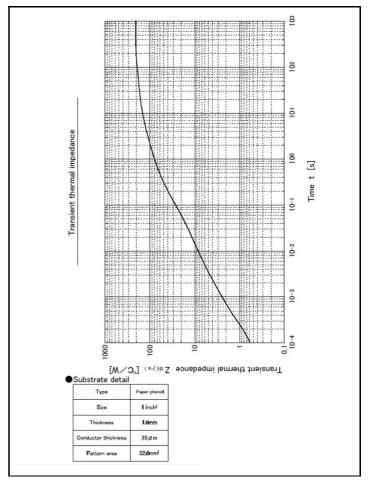








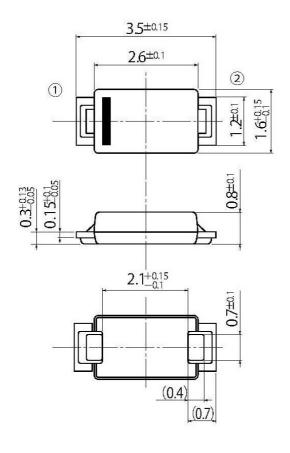


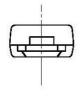


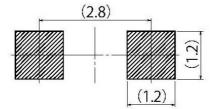
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B1

| JEDEC Code | DO-219AB similar | | |
|------------|------------------|--|--|
| JEITA Code | SC-109 | | |
| House Name | G1F | | |







Referential Soldering Pad

[•] Optimize soldering pad to the board design and soldering condition.

Notes

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(Specific applications)

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